



LI DE HENG ELECTRONICS

DB101 thru DB107

1.0 A Single-Phase Glass Passivated Bridge Rectifiers

Rectifier Reverse Voltage 50 to 1000V



Features

- This series is UL listed under the Recognized Component Index, file number E142814
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Surge overload ratings to 50 amperes
- Ideal for printed circuit board application
- High temperature soldering guaranteed 265°C /10 seconds at 5 lbs (2.3kg) tension

Mechanical Data

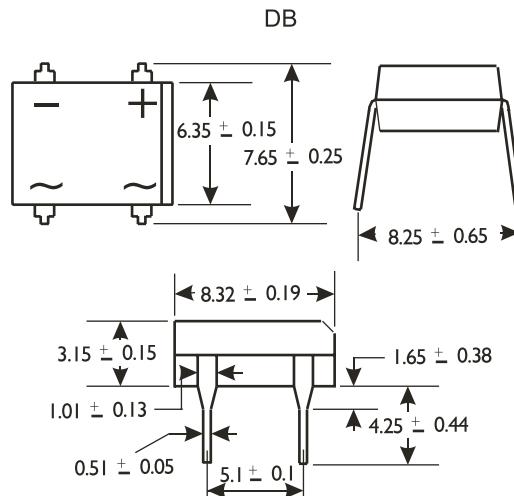
Case: Molded plastic

Terminals: Plated leads solderable per MIL-STD-202, Method 208

Polarity: Marked on body

Mounting Position: Any

Weight: 0.04 ounce, 1.0 grams (approx)



Dimensions in millimeters(1mm = 0.0394")

Maximum Ratings & Thermal Characteristics

Rating at 25°C ambient temperature unless otherwise specified, Resistive or Inductive load, 60 Hz.
For Capacitive load derate current by 20%.

Parameter	Symbol	DB101	DB102	DB103	DB104	DB105	DB106	DB107	unit
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS bridge input voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current at TA=40°C	IF(AV)					1.0			A
Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method)	IFSM					50			A
Rating for fusing (t<8.3ms)	I ² t				10				A ² sec
Typical thermal resistance per element (1)	ReJA				110				°C/W
Typical junction capacitance per element (2)	C _j				25.0				pF
Operating junction and storage temperature range	T _j , T _{STG}				-55 to + 150				°C

Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Resistive or Inductive load, 60Hz.
For Capacitive load derate by 20 %.

Parameter	Symbol	DB101	DB102	DB103	DB104	DB105	DB106	DB107	Unit
Maximum instantaneous forward voltage drop per leg at 1.0A	VF				1.1				V
Maximum DC reverse current at rated TA =25°C DC blocking voltage per element TA =125°C	IR				10 500				μA

Notes: (1)Thermal resistance from Junction to Ambem on P.C.board mounting.

(2)Measured at 2.0MHz and applied reverse voltage of 4.0 volts.

Rating and Characteristic Curves (TA=25°C Unless otherwise noted)
DB101 thru DB107

Fig. 1 Derating Curve for Output Rectified Current

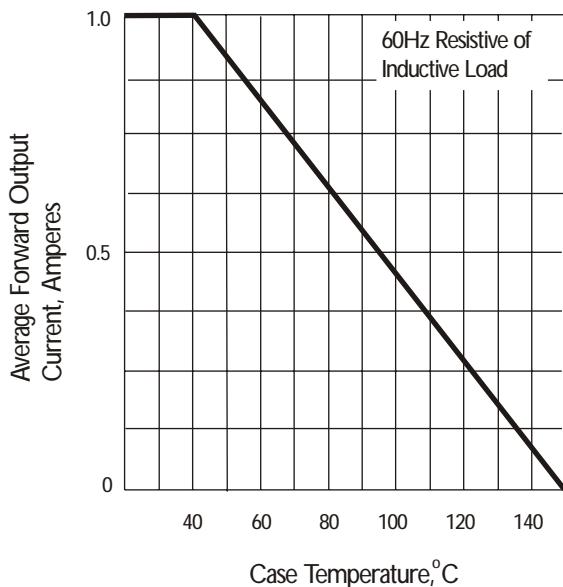


Fig. 2 Maximum Non-repetitive Peak Forward Surge Current

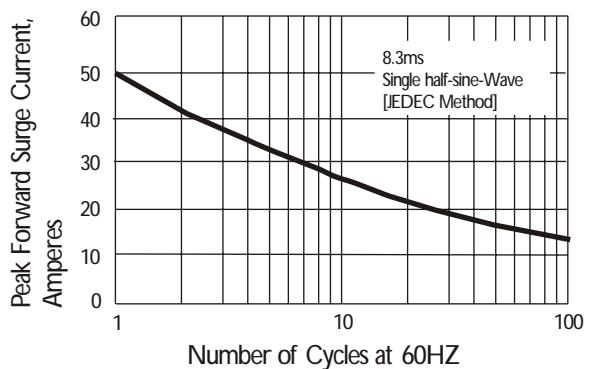


Fig. 3 Typical Instantaneous Forward Characteristics

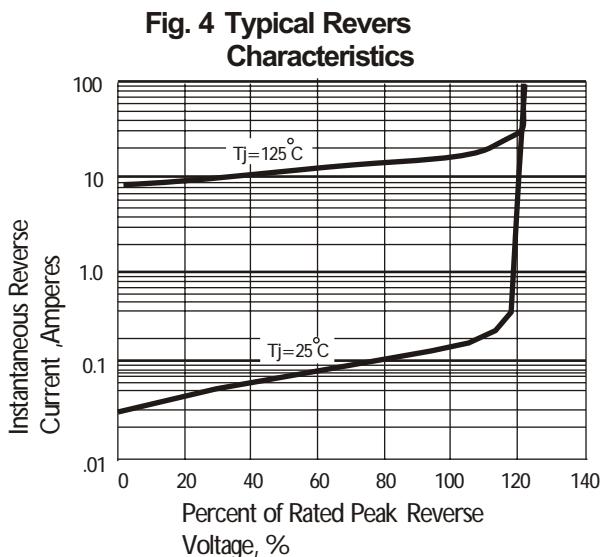
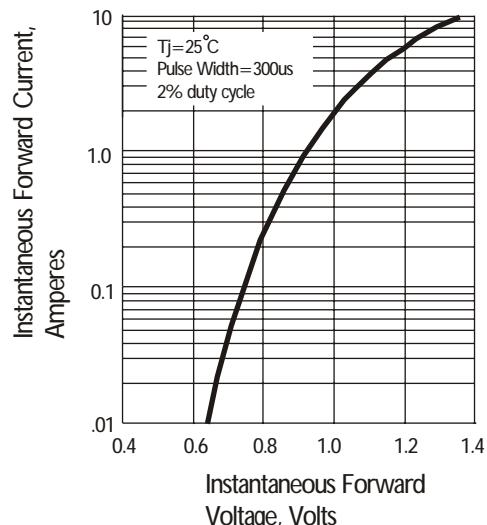


Fig. 5 Typical Junction Capacitance

